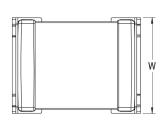
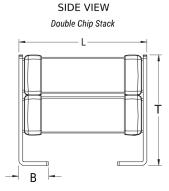






TOP VIEW Single or Double Chip Stack





Click here for the 3D model.

Dimensions	
L	3.5mm +/-0.3mm
W	2.6mm +/-0.3mm
Т	6.15mm +/-0.15mm
В	0.8mm +/-0.15mm

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	300

General Informatio	n .
Series	KPS SMD Comm X7R SnPb
Style	Stacked Chip
Description	SMD, MLCC, Stacked, Double Chip, Temperature Stable
Features	Temperature Stable
RoHS	No
Prop 65	▲ WARNING: Cancer and reproductive harm - http://www.p65warnings.ca.gov.
SCIP Number	795b247e-78a9-405c-8728-223c2d9782a2
Termination	Lead (SnPb)
AEC-Q200	No
Component Weight	290 mg
Chip Size	1210-2
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	22 uF
Measurement Condition	120 Hz 0.5Vrms
Capacitance Tolerance	20%
Voltage DC	25 VDC
Dielectric Withstanding Voltage	62.5 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 120Hz 0.5Vrms
Dissipation Factor	10% 120 Hz 0.5Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	22.7 MOhms

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.